



PolarHV[™]HiPerFET Power MOSFET

IXFP 8N50PM

 $V_{_{DSS}} = 500 V \ I_{_{D25}} = 4.4 A \ R_{_{DS(on)}} \le 0.8 \Omega \ trr \le 200 ns$

(Electrically Isolated Tab)

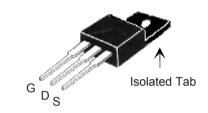
N-Channel Enhancement Mode Avalanche Rated Fast Intrinsic Diode



Symbol	Test Conditions	Maximum	Maximum Ratings		
V _{DSS}	$T_{_{\rm J}}$ = 25° C to 150° C	500	V		
V _{DGR}	$T_{_{\rm J}}$ = 25° C to 150° C; R _{GS} = 1 MΩ	500	V		
V _{GS}	Continuous	±30	V		
V _{GSM}	Transient	±40			
I _{D25}	$T_{_{\rm C}} = 25^{\circ} {\rm C}$	4.4	A		
	$T_{_{\rm C}} = 25^{\circ} {\rm C}$, pulse width limited by $T_{_{\rm JM}}$	14	A		
I _{AR}	T _c = 25° C	8	A		
E _{AR}	T _c = 25° C	20	mJ		
E _{AS}	T _c = 25° C	300	mJ		
dv/dt	$I_{_{S}} \leq I_{_{DM}}$, di/dt ≤ 100 A/ μ s, $V_{_{DD}} \leq V_{_{DSS}}$, $T_{_{J}} \leq 150$ °C, $R_{_{G}}$ = 18 Ω	10	V/ns		
P_{D}	T _C =25°C	42	W		
T _J		-55 +150	°C		
T _{JM}		150	°C		
T _{stg}		-55 +150	°C		
T _L	1.6 mm (0.062 in.) from case for 10 s	300	°C		
T _{SOLD}	Plastic body for 10 s	260	°C		
M _d	Mounting torque	1.13/10	Nm/lb.in.		
Weight		4	g		

Test Conditions Characteristic Values Symbol (T = 25° C unless otherwise specified) Max. Min. Тур. $\mathbf{BV}_{\mathrm{DSS}}$ V $V_{GS} = 0 \text{ V}, I_{D} = 250 \,\mu\text{A}$ 500 $V_{DS} = V_{GS}, I_{D} = 1 \text{ mA}$ 3.0 V 5.5 V_{GS(th)} $V_{GS} = \pm 30 V_{DC}, V_{DS} = 0$ ±100 I_{GSS} nΑ $\mathbf{I}_{\mathrm{DSS}}$ $V_{DS} = V_{DSS}$ $V_{GS} = 0 V$ 5 μΑ T, = 125° C 500 μΑ $V_{GS} = 10 \text{ V}, I_{D} = 4 \text{ A}$ 8.0 Ω R_{DS(on)} Pulse test, t \leq 300 μ s, duty cycle d \leq 2 %

OVERMOLDED TO-220 (IXTP...M) OUTLINE



G = Gate D = Drain S = Source

Features

- Plastic overmolded tab for electrical isolation
- ¹ International standard package
- Unclamped Inductive Switching (UIS) rated
- Low package inductance
 - easy to drive and to protect
- Fast Intrinsic Diode

Advantages

- Easy to mount
- Space savings
- High power density

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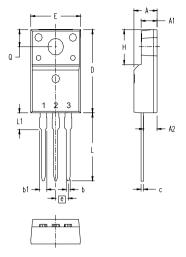
Symbo	l Test Conditions	Cr (T ₁ = 25° C unless		ristic Values
		Min.	Тур.	Max.
g_{fs}	$V_{DS} = 10 \text{ V}; I_{D} = 4 \text{ A}$	5	8	S
C _{iss}			1050	pF
C _{oss}	$V_{GS} = 0 \text{ V}, V_{DS} = 25 \text{ V}, f = 1 \text{ N}$	1Hz	120	pF
\mathbf{C}_{rss}	J		12	pF
t _{d(on)})		22	ns
t _r	$V_{GS} = 10 \text{ V}, V_{DS} = 0.5 V_{DSS}, I_{D}$	= 8 A	28	ns
$\mathbf{t}_{d(off)}$	$R_{\rm G} = 18 \Omega $ (External)		65	ns
$\mathbf{t}_{_{\mathbf{f}}}$	J		23	ns
Q _{g(on)})		20	nC
\mathbf{Q}_{gs}	$V_{GS} = 10 \text{ V}, V_{DS} = 0.5 \text{ V}_{DSS}, I_{DSS}$	= 4 A	7	nC
\mathbf{Q}_{gd}	J		7	nC
R _{thJS}				3.0 ° C/W

Source-Drain Diode

Characteristic Values

I _s		$V_{GS} = 0 V$		8	A
I _{sm}		Repetitive		14	Α
V _{SD}		$I_F = I_S, V_{GS} = 0 \text{ V},$ Pulse test, t \leq 300 μ s, duty cycle d \leq 2 %		1.5	V
t _{rr} Q _{RM} I _{RM}	}	$I_F = 8 \text{ A}, V_{GS} = 0V, V_R = 100V$ $-di/dt = 100 \text{ A}/\mu\text{s}$	0.25	200	ns μC A

ISOLATED TO-220 (IXTP...M)



Terminals: 1 - Gate

2 - Drain (Collector)

3 - Source (Emitter)

MY2	INCHES		MILLIMETERS	
2114	MIN	MAX	MIN	MAX
Α	.177	.193	4.50	4.90
A1	.092	.108	2.34	2.74
A2	.101	.117	2.56	2.96
b	.028	.035	0.70	0.90
b1	.050	.058	1.27	1.47
С	.018	.024	0.45	0.60
D	.617	.633	15.67	16.07
E	.392	.408	9.96	10.36
е	.100	BSC	C 2.54 BSC	
Н	.255	.271	6.48	6.88
L	.499	.523	12.68	13.28
L1	.119	.135	3.03	3.43
ØΡ	.121	.129	3.08	3.28
Q	.126	.134	3.20	3.40

PRELIMINARY TECHNICAL INFORMATION

The product presented herein is under development. The Technical Specifications offered are derived from data gathered during objective characterizations of preliminary engineering lots; but also may yet contain some information supplied during a pre-production design evaluation. IXYS reserves the right to change limits, test conditions, and dimensions without notice.